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Date November 25, 2005

To U.S. Patent Office Central Fax Filing No.

Fax 571 273 8300

From Susan Perng Pan

Our Ref Q77312

Appln No

10/674,396

Conf No 4416

Inventors

Hiroshi TANABE, et al.

Pages _____ (including cover sheet)

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In re application of

Hiroshi TANABE, et al.

Appln. No.: 10/674,396

Group Art Unit: 1763

Confirmation No.: 4416

Examiner: Karla A. MOORE

Filed: October 01, 2003

For: SEMICONDUCTOR MANUFACTURING APPARATUS AND MANUFACTURING METHOD
OF THIN FILM SEMICONDUCTOR DEVICE

PAPER(S) FILED ENTITLED:

RESPONSE UNDER 37 C.F.R. § 1.116

CERTIFICATION OF FACSIMILE TRANSMISSION

Sir:

I hereby certify that the above identified correspondence is being facsimile transmitted to the U.S. Patent and Trademark Office on November 25, 2005 at 571 273 8300.

Respectfully submitted,
Susan Perng Pan, 41239

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RESPONSE UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
GROUP : 763
PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q77312

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Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated August 24, 2005, please consider the remarks as
submitted herewith on the accompanying pages.